

ISO/IEC ~~DISPRF~~ 29158:2024(en)

ISO/IEC JTC 1/SC 31

Secretariat: ANSI

Date: 2025-01-29

**Automatic identification and data capture techniques — Bar code
symbol quality test specification — Direct part mark (DPM)**

*Techniques automatiques d'identification et de capture de données — Ligne directrice de qualité du
marquage direct sur pièce (DPM)*

Second edition

Date: 2024-05-31

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Published in Switzerland.

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Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of document should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives or www.iec.ch/members_experts/refdocs).

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For an explanation of the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT) see www.iso.org/iso/foreword.html. In the IEC, see www.iec.ch/understanding-standards.

This document was prepared by Joint Technical Committee ISO/IEC JTC 1, *Information Technology*, Subcommittee SC 31, *Automatic identification and data capture techniques*.

This second edition cancels and replaces the first edition (ISO/IEC 29158:2020), which has been technically revised.

The main changes are as follows:

- the definition of continuous grading has been deleted (it is now defined in ISO/IEC 15415);
- the rounding method has been revised to always round down.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at www.iso.org/members.html and www.iec.ch/national-committees.

Introduction

Direct part marking (DPM) is a technology whereby, generally, an item is physically altered to produce two different surface conditions. This alteration can be accomplished by various means including, but not limited to, dot peen, laser mark, ink jetting, and electro-chemical etch. The area of the alteration is called "the mark." The area that includes the mark and background as a whole, when containing a pattern defined by a bar code symbology specification, is called "a symbol."

When light illuminates a symbol, it reflects differently depending on whether it impinges on the background of the part or on the physical alteration. In most non-DPM bar code scanning environments, light is reflected off a smooth surface that has been coloured to produce two different diffuse reflected states. The DPM environment generally does not fit this model because the two different reflected states depend on at least one of the states having material oriented to the lighting such that the angle of incidence is equal to the angle of reflection. Sometimes, the material so oriented produces a specular (mirror like) reflectance that results in a signal that is orders of magnitude greater than the signal from diffuse reflectance.

In addition, from the scanner point-of-view, some marking and printing methods generate dots and are not capable of producing smooth lines. This is important for symbologies such as data matrix, which is specified to contain smooth continuous lines, but can be marked with disconnected dots in DPM applications.

Current specifications for matrix symbologies and two-dimensional print quality are not exactly suited to reading situations that have either specular reflection or unconnected dots or both. Additionally, symbologies specified to consist of smooth continuous lines may appear with unconnected dots. This is intended to act as a bridge between the existing specifications and the DPM environment in order to provide a standardized image-based measurement method for DPM that is predictive of scanner performance.

As with all symbology and quality standards, it is the responsibility of the application to define the appropriate parameters of this document for use in conjunction with a particular application.

This document was developed to assess the symbol quality of direct marked parts, where the mark is applied directly to the surface of the item and the reading device is a two-dimensional imager.

When application specifications allow, this method is also potentially applicable to symbols produced by other methods. This is appropriate when DPM symbols and non-DPM symbols are being scanned in the same scanning environment. The symbol grade is reported as a DPM grade rather than as an ISO/IEC 15415 grade.

Automatic identification and data capture techniques — Bar code symbol quality test specification — Direct part mark (DPM)

1 Scope

This document describes ~~the~~ modifications to the symbol quality methodology defined in ISO/IEC 15415 and provides a symbology specification.

This document ~~defines~~~~establishes~~ alternative illumination conditions, some new terms and parameters, modifications to the measurement and subsequent grading of certain parameters, and the reporting of the grading results.

This document is intended for verifier manufacturers and application specification developers.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO/IEC 15415, *Information technology, Automatic identification and data capture techniques — Bar code symbol print quality test specification — Two-dimensional symbols*

ISO/IEC 19762, *Information technology — Automatic identification and data capture (AIDC) techniques — Harmonized vocabulary*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO/IEC ~~19762 and 15415~~, ISO/IEC ~~15415~~~~19762~~ and the following apply.

ISO and IEC maintain ~~terminological~~~~terminology~~ databases for use in standardization at the following addresses:

- ISO Online browsing platform: available at <https://www.iso.org/obp>
- IEC Electropedia: available at <https://www.electropedia.org/>

3.1 ~~3.1~~

reference symbol

high-contrast printed calibration card for which results are traceable back to national or international standards and for which the supplier supplies a calibration certificate

3.2 ~~3.2~~

stick

line segment comprised of image pixels that is used to connect areas of the same colour that are near to each other

4 Symbols and abbreviated terms

CM cell modulation

~~CC~~ cell contrast

4.1 Symbols

C_c value of cell contrast

~~C_{MOD} cell module modulation~~

C_{MOD} value of cell module modulation

f_x remaining distance fraction of the x position

f_y remaining distance fraction of the y position

g current threshold of the grid-centre point histogram in the calculation of the optimal threshold according to [Annex A](#)

M_D mean of the grid-centre point histogram of the dark elements

M_L mean of the grid-centre point histogram of the light elements

M_{Lcal} mean of the light lobe from a histogram of the calibrated standard

$M_{Ltarget}$ mean of the light lobe from the final grid-centre point histogram of the symbol under test

R measured reflectance of the cell

R_{cal} reported reflectance value, R_{max} , from a calibration standard

R_{target} measured percent reflectance of the light elements of the symbol under test relative to the calibrated standard

~~NOTE — R_{target} is graded and reported as the parameter named “Minimum Reflectance”.~~

~~NOTE — R_{target} is graded and reported as the parameter named “minimum reflectance”.~~

S_{Rcal} system response parameters (such as exposure and/or gain) used to create an image of the calibration standard

$S_{Rtarget}$ system response parameters (such as exposure and/or gain) used to create an image of the symbol under test

T_1 threshold created using a histogram of the defined grey scale pixel values in a circular area 20 times the aperture size in diameter, centred on the image centre using the algorithm ~~defined given~~ in [Annex A](#)

T_2 threshold created using the histogram of the reference grey scale image pixel values at each intersection point of the grid using the method ~~defined given~~ in [Annex A](#)

T_{min} current minimum threshold in the calculation of the optimal threshold according to [Annex A](#)

T_{max} current maximum threshold in the calculation of the optimal threshold according to [Annex A](#)

~~TCL tilted coaxial lighting and camera position~~

V current sum of two variances according to [Annex A](#)

V_D current variance of the grid-centre point histogram of the dark elements according to [Annex A](#)

V_L current variance of the grid-centre point histogram of the light elements according to [Annex A](#)

V_{min} current minimum variance in the calculation of the optimal threshold according to [Annex A](#)

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x	x position on the camera image plane
x'	x position on the virtual camera plane
x_p	x position of image pixel on the camera image plane
y	y position on the camera image plane
y'	y position on the virtual camera plane
y_p	y position of image pixel on the camera image plane

4.2 Abbreviated terms

CM	<u>cell modulation</u>
CC	<u>cell contrast</u>
CMOD	<u>cell module modulation</u>
DFPD	<u>distributed fixed pattern damage</u>
FPD	<u>fixed pattern damage</u>
TCL	<u>tilted coaxial lighting and camera position</u>

5 Overview of methodology

5.1 Process differences from ISO/IEC 15415

All parameters in the symbology and print quality specifications apply except for:

- ~~multi-row bar code symbols are not supported by the method described in this document;~~
- ~~a different method for setting the image contrast;~~
- ~~a new method for choosing the aperture size;~~
- ~~an image pre-process methodology for joining disconnected modules in a symbol (where applicable);~~
- ~~a different process for determining the modulation parameter which has been renamed cell modulation (CM);~~
- ~~a different process for determining the symbol contrast parameter which has been renamed cell contrast (CC);~~
- ~~a different process for computing FPD;~~
- ~~Aa~~ a new parameter called minimum reflectance (R_{target}).

This document explains how to both specify and report quality grades in a manner complementary to, yet distinct from, the method in ISO/IEC 15415.

NOTE [Annex E](#) gives a cross reference comparison of this document to ISO/~~IEC 15415~~ IEC 15415.

5.2 Lighting

Lighting environments shall be reported ~~according to 6.2~~ in accordance with 6.2 and 10.2. The lighting environment(s) shall be selected by the application specification in consideration of the properties of the mark and the requirements of the reading equipment and environment of the application.

5.3 Tilted coaxial lighting and camera position ~~(TCL)~~

~~TCL~~Tilted coaxial lighting and camera position (TCL) is useful for DPM applications that use a geometrical mark which is peened, drilled or carved into a surface. Reading camera and unidirectional illumination are located at a coaxial position with a known fixed tilt angle and object rotation angle and position.

To read dot-peened codes, there are multiple reading setups possible. This document defines several camera and lighting setups in order to address various dot peen geometries.

This specific TCL environment is focussing on the system response of the mark (e.g. the image a camera sees). SAE Standard AS9132^[24] takes a different approach to specify the mark geometry.

[Figure 1](#) ~~Figure 1~~ illustrates the setup. The essential parameter is the camera reading angle. Typical camera reading angles include 30°, 45° or 60° in relation to the plane of the mark.

NOTE 1 The camera angle is defined in a compatible way to the lighting angle of ISO/IEC 15415:2024, Figure 1.

NOTE 2 Within the dot peen industry, it is common to specify the stylus angle which is twice the camera angle given in [Figure 1](#) ~~Figure 1~~.

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